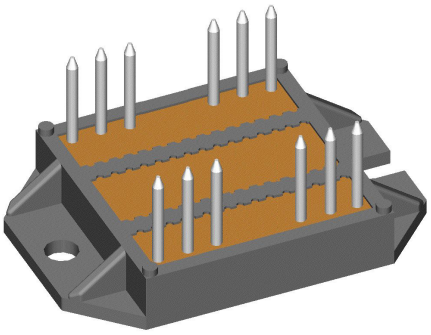
preliminary data

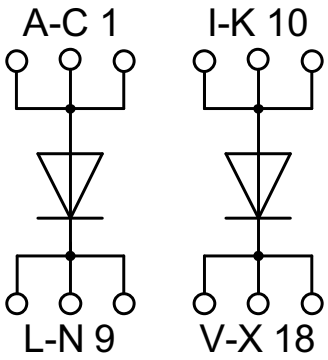
Fast Recovery Epitaxial Diode (FRED)

I_{FAVM} = 2x 165 A
V_{RRM} = 200 V
t_{rr} = 35 ns

Part number

DSEI2x161-02P





Features / Advantages:

- 2 independent FRED in 1 package
- Planar passivated chips
- Very short recovery time
- Leads suitable for PC board soldering
- Very short recovery time
- Soft recovery behaviour
- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling capability
- Low noise switching
- Small and light weight

Applications:

- Antiparallel diode for high frequency switching devices
- Anti saturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Package: ECO-PAC2

- Isolation voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 9 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

preliminary data

Diode				Ratings			
Symbol	**Definitions**	**Conditions**		**min.**	**typ.**	**max.**	
I_{FRMS}	*RMS forward current*		$T_{VJ} = T_{VJM}$			270	A
I_{FAVM} ①	*max. average forward current*	rectangular, d = 0.5	T_C = 70°C			165	A
I_{FSM}	*max. surge forward current*	t = 10 ms (50 Hz), sine	T_{VJ} = 45°C			1200	A
		t = 8.3 ms (60 Hz), sine				1300	A
		t = 10 ms (50 Hz), sine	T_{VJ} = 150°C			1080	A
		t = 8.3 ms (60 Hz), sine				1170	A
I^2t	*I^2t value for fusing*	t = 10 ms (50 Hz), sine	T_{VJ} = 45°C			7200	A^2s
		t = 8.3 ms (60 Hz), sine				7100	A^2s
		t = 10 ms (50 Hz), sine	T_{VJ} = 150°C			5800	A^2s
		t = 8.3 ms (60 Hz), sine				5700	A^2s
I_R	*reverse current*	$V_R = V_{RRM}$	T_{VJ} = 25°C			3	mA
		$V_R = 0.8 \cdot V_{RRM}$	T_{VJ} = 25°C			2	mA
		$V_R = 0.8 \cdot V_{RRM}$	T_{VJ} = 125°C			80	mA
V_F	*forward voltage*	I_F = 200 A	T_{VJ} = 25°C			1.2	V
V_{T0}	*threshold voltage*	for power-loss calculations only	$T_{VJ} = T_{VJM}$			0.53	V
r_T	*slope resistance*					2.6	mΩ
R_{thJC}	*thermal resistance junction to case*					0.29	K/W
R_{thCH}	*thermal resistance junction to heatsink*				0.20		K/W
I_{RM}	*max. reverse recovery current*	I_F = 100 A; $-di_F/dt$ = 200 A/µs	T_{VJ} = 100°C		20		A
		V_R = 100 V; L ≤ 0.05 µH					
t_{rr}	*reverse recovery time*	I_F = 1 A; -di/dt = 400 A/µs; V_R = 30 V	T_{VJ} = 25°C		35		ns

① I_{FAVM} rating includes reverse blocking losses at T_{VJM}, $V_R = 0.8\ V_{RRM}$, duty cycle d = 0.5

Package	**ECO-PAC2**			**Ratings**			
Symbol	**Definitions**	**Conditions**		**min.**	**typ.**	**max.**	
I_{RMS}	*RMS current*	per terminal				100	A
T_{VJ} T_{op} T_{stg}	*virtual junction temperature* *operation temperature* *storage temperature*			-40 -40 -40		150 125 125	°C °C °C
Weight					24		g
M_D	*mounting torque*			1.4		2.0	Nm
$d_{Spp/App}$ $d_{Spb/Apb}$	*creepage distance on surface | striking distance through air*		terminal to terminal terminal to backside	6.0 10.0			mm mm
V_{ISOL}	*isolation voltage*	t = 1 second t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000 2500			V V